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MEMC 00-1400(2806.1)
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of Robert J. Falster et al.

Art Unit 1765

Serial No. 10/039,196

Filed January 2, 2002

Confirmation No. 7221

For PROCESS FOR PREPARING SINGLE CRYSTAL SILICON HAVING
IMPROVED GATE OXIDE INTEGRITY

March 6, 2002

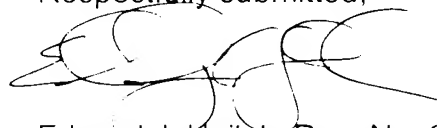
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SUPPLEMENTAL APPLICATION DATA SHEET

SIR:

Applicants listed some incorrect inventor information on the Application Data Sheet filed on January 2, 2002 respecting the above-referenced application. There was also a misspelling on the filing receipt received. In accordance with 37 CFR 1.76(d)(3) & (4), Applicants respectfully submit herewith a Supplemental Application Data Sheet. Applicants also respectfully request a corrected filing receipt reflecting this correction.

Respectfully submitted,



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*Enclosure



SUPPLEMENTAL APPLICATION DATA SHEET

Application Information

<u>Serial No.::</u>	<u>10/039,196</u>
<u>Filing Date::</u>	<u>January 2, 2002</u>
Application Type::	Non-Provisional
Subject Matter::	Utility
Title::	Process For Preparing Single Crystal Silicon Having Improved Gate Oxide Integrity
Attorney Docket Number::	MEMC 00-1400(2806.1)
Request for Early Publication::	No
Request for Non-Publication::	No
Total Drawing Sheets::	17
Small Entity::	No
Petition Included::	No
Secrecy Order in Parent::	No

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Correspondence Information

Correspondence Customer Number:: 000321

Representative Information

Representative Customer Number:: 000321

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	Non-Provisional of	60/259,362	01/02/02

Assignee Information

Assignee Name:: MEMC Electronic Materials, Inc.